



 <p><b>Masach Technologies</b> Board Level Shielding Design &amp; fabrication</p>	Item No:	Description:	Material:
	<b>MS233-20</b>	DRAWN RF SHIELD FRAME + COVER	TIN STEEL (See Note 1-2)
	<b>Note:</b> (1) TS275E 8.4/8.4 (2) Electrolytic Tin Plate As Per EN 10202:2001 Min Tin Thickness 3.5 $\mu$ m (3) General tolerance $\pm 0.2$ mm Non Dimensioned items remain <b>Masach Technologies LTD</b> property.		
<a href="http://www.masach.com">www.masach.com</a>		MMGS / Print 1:1 / A4	